

Notice of References Cited	Application/Control No. 10/535,026		Applicant(s)/Patent Under Reexamination BHATTACHARYA ET AL.	
	Examiner EDNA WONG		Art Unit 1795	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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*	B	US-5,873,992	02-1999	Glezen et al.	205/159
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	L	US-			
	M	US-			

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NON-PATENT DOCUMENTS

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	W	Nikolova, "Structure of Gold Coatings and Gold Electrodeposition Processes From Cyanide-Free Electrolytes. II. Effect of the Substrate and Dependence of the Texture to Coating Formation", Izvestiya po Khimiya (no month, 1977), Vol. 10, No. 3, pp. 345-60). ABSTRACT ONLY (1 page).
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.